

Preface

ICISC 2013, the 16th International Conference on Information Security and Cryptology, was held in Seoul, Korea, during November 27–29, 2013. This year’s conference was hosted by the KIISC (Korea Institute of Information Security and Cryptology) jointly with the NSRI (National Security Research Institute), in cooperation with the Ministry of Science, ICT and Future Planning (MSIP).

The aim of this conference is to provide an international forum for the latest results of research, development, and applications in the field of information security and cryptology. This year we received 126 submissions from more than 20 countries and were able to accept 31 papers from 14 countries, with an acceptance rate of 24.6 %. The review and selection processes were carried out by the Program Committee (PC) members, 86 prominent experts worldwide, via the IACR review system. Submissions by Program Committee members received at least five reviews. The review process was double-blind, and conflicts of interest were handled carefully.

The conference featured two invited talks: “Making NTRUEncrypt and NTRUSign as Secure as Worst-Case Problems over Ideal Lattices” by Damien Stehlé and “Introduction to Quantum Cryptography and Its Technology Trends” by Jeong Woon Choi. We thank the invited speakers for their kind acceptance and nice presentations.

We would like to thank all authors who submitted their papers to ICISC 2013 and all of the 86 PC members. It was a truly great experience to work with such talented and hard-working researchers. We also appreciate the external reviewers for assisting the PC members in their particular areas of expertise. Finally, we would like to thank all attendees for their active participation and the organizing team who nicely managed this conference. We look forward to seeing you again at next year’s ICISC.

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